



PRODUCT DATA



Micro International, Inc

PART NUMBER

LDTBFW30 and LDTBFW30T

Micro-LID NPN Transistor



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**Micro-LID Transistors
LDTBFW30 and LDTBFW30T**

Description:

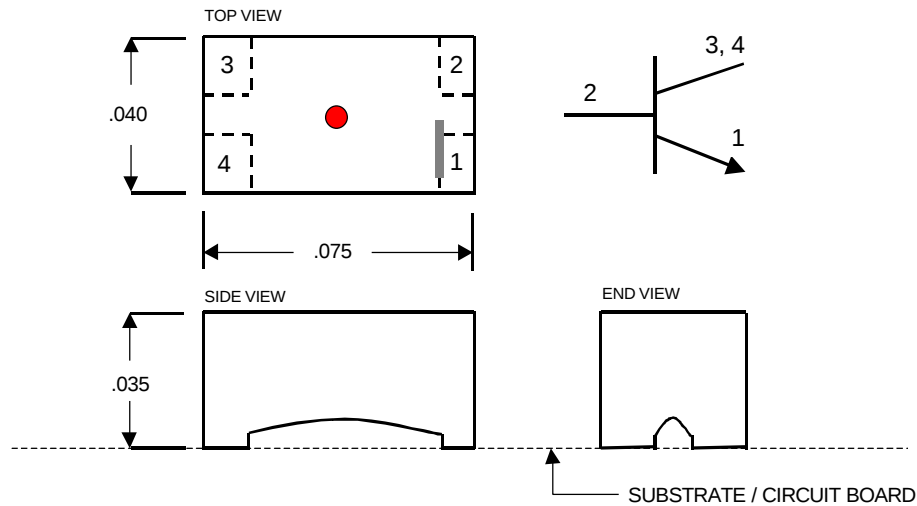
The LDTBFW30 (untinned) and LDTBFW30T (tinned) are NPN silicon 1.6 GHz wideband transistors in very small, rugged, surface mount, 4-post ceramic packages (Micro International manufactured package p/n 4-075-1). The LDTBFW30 and LDTBFW30T meet the general specifications of the BFW30 transistor. The 4-075-1 Micro-LID package is a 4-post, leadless ceramic carrier which can be provided with gold metallized or pre-tinned lands, and is approved for military, medical implant, sensor, and high reliability applications. The LDTBFW30 and LDTBFW30T can be provided with special feature options such as additional temperature cycling, screening, and matching Hfe selection.

Maximum Ratings:

Parameter	Symbol	Rating
Collector-Base Voltage	Vcbo	20 V
Collector-Emitter Voltage	Vceo	10 V
Emitter-Base Voltage	Vebo	2.5 V
Collector Current	Ic	50 mA
Total Dissipation	Pt	350 mW
Operating Junction Temperature	Tj	150°C
Storage Temperature	Tstg	-65°C to 150°C
Operating Temperature	Toper	-55°C to 125°C

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Outline / Schematic:



Dimensions / Marking:

Length	.075" $\pm$.003"	Post 1 (Emitter)	.015" x .010" typ
Width	.040" $\pm$.003"	Post 2 (Base)	.015" x .010" typ
Height	.035" $\pm$.003"	Post 3,4 (Collector)	.015" x .012" typ

Marking on back of package : Gray Stripe over Emitter and Red Dot in Center
(post down configuration)

Standard In-Process Screening Requirements:

- Semiconductor die and Micro-LID package visual inspection
- Wire pull test
- 24 hour stabilization bake at 150°C
- 10 temperature cycles from -55°C to 125°C
- 100% electrical test of dc characteristics at 25°C
- Final visual inspection

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Electrical Characteristics (25 °C Ambient)

Parameter	Symbol	Min	Typ	Max	Units
Collector-Base Breakdown $I_c = 100 \mu A, I_e = 0$	BVcbo	20	--	--	V
Collector-Emitter Breakdown* $I_b = 0, I_c = 10 \text{ mA}$	BVceo	10	--	--	V
Emitter-Base Breakdown $I_c = 0, I_e = 100 \mu A$	BVebo	2.5	--	--	V
Collector-Base Cutoff Current $V_{cb} = 10 \text{ V}$	Icbo	--	--	50	nA
DC Forward Current Gain* $I_c = 25 \text{ mA}, V_{ce} = 5 \text{ V}$ $I_c = 50 \text{ mA}, V_{ce} = 5 \text{ V}$	Hfe	25 25	-- --	-- --	
Collector Capacitance $V_{cb} = 5 \text{ V}, I_e = 0$ $f = 1 \text{ MHz}$	Cobo	--	--	1.5	pF
Gain Bandwidth Product $I_c = 50 \text{ mA}, V_{ce} = 5 \text{ V}$ $f = 500 \text{ MHz}$	fT	--	1.6	--	GHz
Noise Figure $I_c = 2 \text{ mA}, V_{ce} = 5 \text{ V}$ $f = 500 \text{ MHz}$	NF	--	--	5	dB

* Pulse test, pulse width $\leq 300 \text{ usec}$, duty cycle $\leq 2\%$
